

[54] ORNAMENTAL DESIGN FOR A FRAME OF
CIRCUIT ELEMENTS UTILIZED TO
REPLACE DAMAGED ELEMENTS ON
PRINTED CIRCUIT BOARDS

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D9/337, 341, 456, 424, 345, 347

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[57] CLAIM

The ornamental design for a frame of circuit elements utilized to replace damaged elements on printed circuit boards, as shown and described.

DESCRIPTION

The sole FIGURE is a top plan view of the frame of circuit elements utilized to replace damaged elements on printed circuit boards showing my new design. The frame is flat with no substantial thickness and the bottom surface is identical to the top.



